

Surface Mount Schottky Power Rectifier

SMA/SMB Power Surface Mount Package

MBRS2H100T3G. NBRS2H100NT3G, MBRA2H100T3G, NRVBA2H100NT3G

This device employs the Schottky Barrier principle in a metal-to-silicon power rectifier. Features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for low voltage, high frequency switching power supplies; free wheeling diodes and polarity protection diodes.

Features

- Compact Package with J-Bend Leads Ideal for Automated Handling
- Highly Stable Oxide Passivated Junction
- Guard-Ring for Overvoltage Protection
- Low Forward Voltage Drop
- NBR and NRVB Prefixes for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable*

Mechanical Characteristics

- Case: Molded Epoxy
- Epoxy Meets UL 94 V-0 @ 0.125 in
- Weight: 70 mg (SMA), 95 mg (SMB) (Approximately)
- Cathode Polarity Band
- Lead and Mounting Surface Temperature for Soldering Purposes: 260 °C Max. for 10 Seconds
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- ESD Ratings:
 - ◆ Charged Device Model > 1000 V (Class C5)
 - ♦ Human Body Model = 3B
- These Devices are Pb-Free and are RoHS Compliant
- Device Meets MSL1 Requirements

SCHOTTKY BARRIER RECTIFIER 2.0 AMPERES, 100 VOLTS

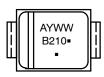




MARKING



SMB CASE 403A



A210 = MBRA2H100T3G = MBRS2H100T3G B210 = Assembly Location Α = Year

WW = Work Week = Pb-Free Package

(Note: Microdot may be in either location)

**The Assembly Location code (A) is front side optional. In cases where the Assembly Location is stamped in the package, the front side assembly code may be blank.

ORDERING INFORMATION

Device	Package	Shipping [†]
MBRA2H100T3G	SMA (Pb-Free)	5,000 / Tape & Reel
MBRS2H100T3G, NBRS2H100NT3G*	SMB (Pb-Free)	2,500 / Tape & Reel
NRVBA2H100NT3G*	SMA (Pb-Free)	5,000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	100	V
Average Rectified Forward Current (T _L = 150 °C)	lo	2.0	Α
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I _{FSM}	130	Α
Storage Temperature Range	T _{stg}	-65 to +175	°C
Operating Junction Temperature (Note 1)	TJ	-65 to +175	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction-to-Lead (Note 2) MBRA2H100T3G, NRVBA2H100NT3G MBRS2H100T3G, NBRS2H100NT3G	$\Psi_{\sf JCL}$	14 12	°C/W
Thermal Resistance, Junction-to-Ambient (Note 2) MBRA2H100T3G, NRVBA2H100NT3G MBRS2H100T3G, NBRS2H100NT3G	$R_{ hetaJA}$	75 71	°C/W
Thermal Resistance, Junction-to-Ambient (Note 3) MBRA2H100T3G, NRVBA2H100NT3G MBRS2H100T3G, NBRS2H100NT3G	$R_{ hetaJA}$	275 230	°C/W

^{2.} Mounted with 700 mm square copper pad size (Approximately 1 inch square) 1 oz FR4 Board.

ELECTRICAL CHARACTERISTICS

		Value		
Characteristic	Symbol	T _J = 25 °C	T _J = 125 °C	Unit
Maximum Instantaneous Forward Voltage (Note 4) (i _F = 2.0 A)	VF	0.79	0.65	٧
Maximum Instantaneous Reverse Current (Note 4) (V _R = 100 V)	I _R	0.008	1.5	mA

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

^{1.} The heat generated must be less than the thermal conductivity from Junction-to-Ambient: $dP_D/dT_J < 1/R_{\theta JA}$.

^{3.} Mounted with minimum recommended pad size 1 oz FR4 Board.

^{4.} Pulse Test: Pulse Width ≤ 380 μs, Duty Cycle ≤ 2.0%.

TYPICAL CHARACTERISTICS

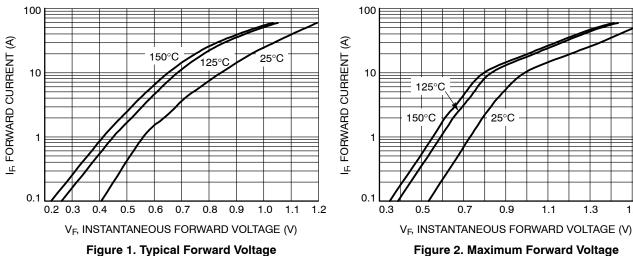


Figure 2. Maximum Forward Voltage

1.3

1.5

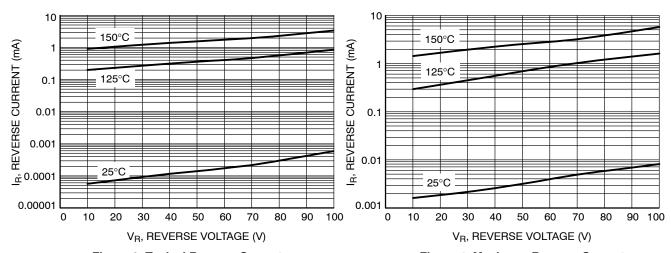


Figure 3. Typical Reverse Current

Figure 4. Maximum Reverse Current

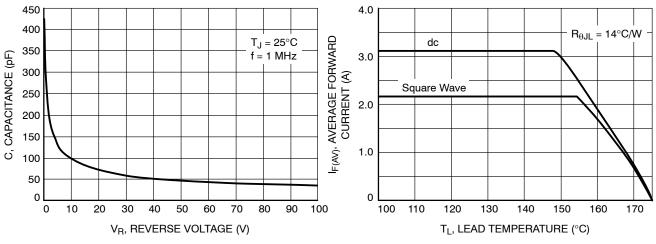
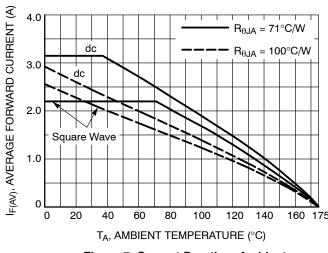


Figure 5. Typical Capacitance

Figure 6. Current Derating - Lead

TYPICAL CHARACTERISTICS



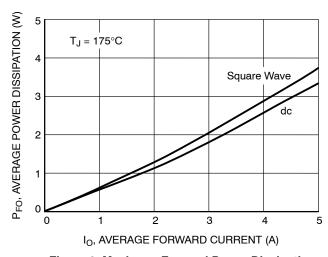


Figure 7. Current Derating, Ambient

Figure 8. Maximum Forward Power Dissipation

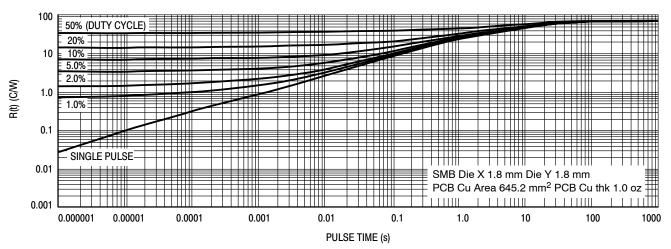


Figure 9. Thermal Response, Junction-to-Ambient (1 inch pad) - MBRS2H100T3G/NBRS2H100NT3G

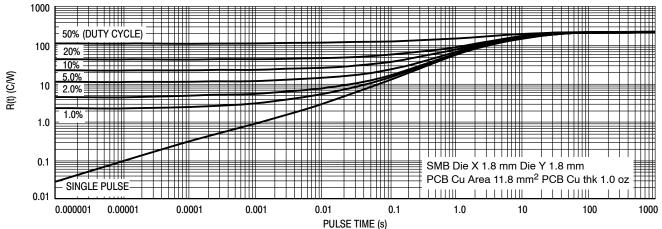


Figure 10. Thermal Response, Junction-to-Ambient (min pad) – MBRS2H100T3G/NBRS2H100NT3G

TYPICAL CHARACTERISTICS

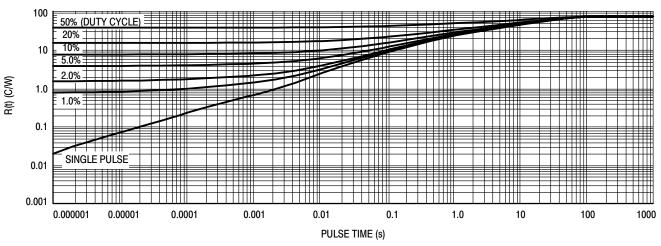


Figure 11. Thermal Response, Junction-to-Ambient (1 inch pad) - MBRA2H100T3G

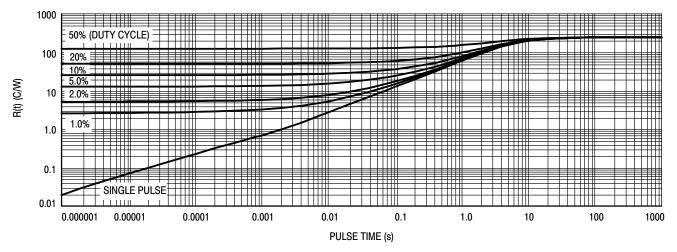


Figure 12. Thermal Response, Junction-to-Ambient (min pad) - MBRA2H100T3G

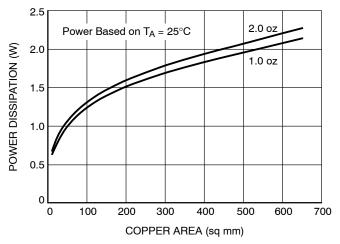


Figure 13. P_D, Junction-to-Ambient (URS copper area)

REVISION HISTORY

Revision	Description of Changes	Date
16	Remove EOL device information	8/1/2025

This document has undergone updates prior to the inclusion of this revision history table. The changes tracked here only reflect updates made on the noted approval dates.





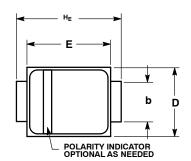


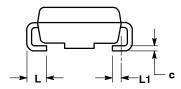
SMB CASE 403A-03 **ISSUE J**

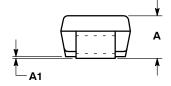
DATE 19 JUL 2012

Polarity Band

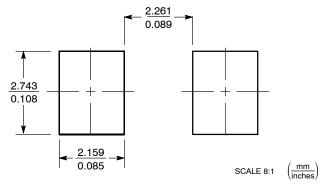
SCALE 1:1 Non-Polarity Band







SOLDERING FOOTPRINT*



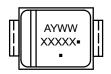
*For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCL.
- CONTROLLING DIMENSION: INCH.
 DIMENSION b SHALL BE MEASURED WITHIN DIMENSION L1.

	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	1.95	2.30	2.47	0.077	0.091	0.097
A1	0.05	0.10	0.20	0.002	0.004	0.008
b	1.96	2.03	2.20	0.077	0.080	0.087
С	0.15	0.23	0.31	0.006	0.009	0.012
D	3.30	3.56	3.95	0.130	0.140	0.156
E	4.06	4.32	4.60	0.160	0.170	0.181
HE	5.21	5.44	5.60	0.205	0.214	0.220
L	0.76	1.02	1.60	0.030	0.040	0.063
L1		0.51 REF			0.020 REF	

GENERIC MARKING DIAGRAM*





Polarity Band

Non-Polarity Band

XXXXX = Specific Device Code = Assembly Location

= Year WW = Work Week = Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "■", may or may not be present. Some products may not follow the Generic Marking.

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STYLE 1 STYLE 2

SCALE 1:1

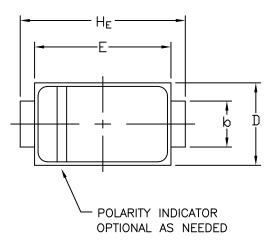
SMA CASE 403D ISSUE J

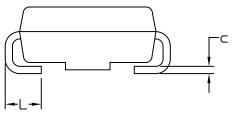
DATE 22 OCT 2021

NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: INCHES
- 3. DIMENSION & SHALL BE MEASURED WITHIN DIMENSION L.

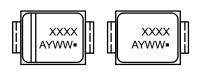
	MILLIMETERS				INCHES	
DIM	MIN.	N□M.	MAX.	MIN.	N□M.	MAX.
Α	1.97	2.10	2.20	0.078	0.083	0.087
A1	0.05	0.10	0.20	0.002	0.004	0.008
b	1.27	1.45	1.63	0.050	0.057	0.064
С	0.15	0.28	0.41	0.006	0.011	0.016
D	2.29	2.60	2.92	0.090	0.103	0.115
Ε	4.06	4.32	4.57	0.160	0.170	0.180
HE	4.83	5.21	5.59	0.190	0.205	0.220
L	0.76	1.14	1.52	0.030	0.045	0.060





STYLE 1: STYLE 2: PIN 1. CATHODE (POLARITY BAND) NO POLARITY 2. ANODE

GENERIC MARKING DIAGRAM*



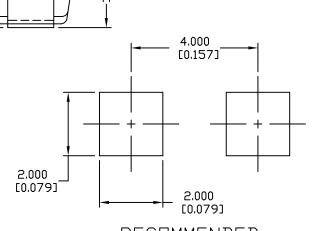
XXXX = Specific Device Code A = Assembly Location

STYLE 2

STYLE 1

Y = Year WW = Work Week ■ = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.



RECOMMENDED MOUNTING FOOTPRINT

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